

VACUUM RELEASE (VR) PRODUCT SERIES CARRIER

Product Datasheet

Gel-Pak's Vacuum Release Carrier (VR, VRP, VRV Product Series) is an extremely versatile "pocketless" tray that securely holds fragile devices including bare die during shipping, handling and processing. It is ideal for high-volume pick and place applications.

The surface of the VR carrier uses a proprietary Gel or non-silicone Vertec[™] film membrane over a mesh material to hold components in place until they are released by applying vacuum to the underside of the tray.

Ideal for:

- High-volume automated device Pick & Place applications.
- Extremely fragile or thin devices.
- Handling bare die.
- No contact with edges or top surface of device.
- Handling device sizes (X, Y) ranging from <250 micron to 75mm.





VR Tray in Vacumm Release VR Tray on Automated Pick and Mode Place

Material Properties	VR	VRP	VRV
Elastomer	Purified Silicone Film	Cross-linked Polyurethane Film	Extruded TPE Film
Feature	Insulative (Silicone gel)	Static Dissipative (Silicone free gel)	Insulative (Silicone free gel)
ESD SR (ohms)	>1012	<10 ⁹	>10 ¹²
Appearance	Clear	Clear	Hazy
Ease of Unload	Best	Good	ОК
Ultra-Low Level	ХТ	EH01	-
Low Tack Level	XL	EH02	FP64
Medium Tack Level	X4, X6	EH04	FM71
High Tack Level	X8	EH06	FK79
Operating Max Temp	75°C	35°C	35°C
Shelf Life	2 years	2 years	2 years

NOTES: 1. These values are for reference purposes only and are not intended for use in preparing specifications.

- 2. Extended temperature ranges are possible; however, testing may be needed.
- 3. VR tray carrier sizes were available in 2", 4" and Large Format for >75mm.

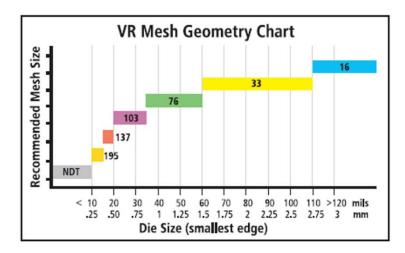


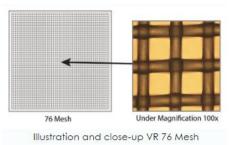
Division of DELPHON

Mesh to Device size Selection Guide:

The correct Mesh Geometry (also referred to as Mesh Size) for a specific device is based on the device X, Y dimensions. Gel-Pak offers a range of different mesh geometries: 16, 33, 76, 103, 137, 195. Each mesh size number corresponds to the number of thread lines per linear inch. If the device is smaller than 254um x 254um, refer to the special NDT product page,

⇒ Nano Device Tray (NDT) | Developing Unique Materials For Device Handling | Hayward, CA





Tray/Lid or Box carrier component/material configuration:

Tray / Lid configuration (00A / 00B)			
Component	Material		
Tray, Black Conductive (C)	Polycarbonate		
Tray, Transparent (T)	Polystyrene		
Lid Transparent (T)	Polystyrene		
Lid, Black Conductive (C)	Polycarbonate		
Lid, Antistatic (AS)	ABS		

Tray / Box configuration (02)			
Component	Material		
Box, Black Conductive Hinged (C)	Polycarbonate		
Box, Antistatic Hinged (AS)	ABS		
Box, Transparent Hinged (T)	Polystyrene		

Note: Use "00B" configuration for 4" tray/lid size.

Print Options:

⇒ Prints | Developing Unique Materials For Device Handling | Hayward, CA

References:

- ⇒ Gel-Pak Vacuum Release™ (VR) Trays (VR, VRP, VRV Series) | Developing Unique Materials For Device Handling | Hayward, CA
- □ Gel-Pak Wafer/Large Format VR Plates® | Developing Unique Materials For Device Handling | Hayward, CA